

## **General Description**

The WSD40P10DN56 is the highest performance trench P-Channel MOSFET with extreme high cell density, which provide excellent  $R_{DS(ON)}$  and gate charge for most of the synchronous buck converter applications.

The WSD40P10DN56 meet the RoHS and Green Product requirement, 100%  $E_{AS}$  guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% E<sub>AS</sub> Guaranteed
- Green Device Available

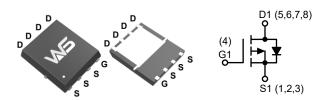
## **Product Summery**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>
-100V	78mΩ	-30A

## **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

## **DFN5X6-8L Pin Configuration**



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage -100		V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup>	-30	
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ -10V <sup>1</sup>	-15	А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	-75	
E <sub>AS</sub>	Single Pulse Avalanche Energy <sup>3</sup>	157	mJ
I <sub>AS</sub>	Avalanche Current	-18.9	А
P <sub>D</sub> @T <sub>C</sub> =25°C	P <sub>D</sub> @T <sub>C</sub> =25°C Total Power Dissipation <sup>4</sup>		W
T <sub>STG</sub>	Storage Temperature Range -55 to 150		°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	C

### **Thermal Data**

Symbol	Parameter Parameter		Max.	Units
$R_{ heta JA}$	R <sub>θJA</sub> Thermal Resistance Junction-Ambient <sup>1</sup>		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		2.3	C/VV



## **Electrical Characteristics** (T<sub>J</sub>=25°C, Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250μA	-100			V
$\Delta BV_{DSS}/\Delta T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =-1mA		-0.021		V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-15A		78	95	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	\/ -\/     - 250\	-1.2	-1.7	-2.5	V
$\Delta V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_{D}=-250\mu$ A		4.08		mV/°C
	Zoro Cato Voltago Drain Current	V <sub>DS</sub> =-48V , V <sub>GS</sub> =0V ,T <sub>J</sub> =25°C			1.0	μΑ
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-48V , V <sub>GS</sub> =0V ,T <sub>J</sub> =55°C			5.0	
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-10A		24		S
Qg	Total Gate Charge(-4.5)			44		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =-50V , V <sub>GS</sub> =-10V , I <sub>D</sub> =-20A		9		nC
$Q_{\mathrm{gd}}$	Gate-Drain Charge			6		
T <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ =-30V , $V_{GS}$ =-10V , $R_{G}$ =6 $\Omega$ , $I_{D}$ =-10A , $R_{L}$ =30 $\Omega$		12		
T <sub>r</sub>	Rise Time			27		
T <sub>d(off)</sub>	Turn-Off Delay Time			79		ns
T <sub>f</sub>	Fall Time			53		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-30V , V <sub>GS</sub> =0V , f = 1.0MHz		3029		
C <sub>oss</sub>	Output Capacitance			129		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			76		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
I <sub>S</sub>	Continuous Source Current 1,6	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			-18	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C			-1.2	V

#### Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t≤10sec.
- 2. The data tested by pulsed , pulse width  $\leq 300 \mu s$  , duty cycle  $\leq 2\%$
- 3. The E $_{AS}$  data shows Max. rating . The test condition is  $V_{DD}$ =-25V,  $V_{GS}$ =-10V, L=0.5mH, I $_{AS}$ =-25A
- 4. The power dissipation is limited by 150°C junction temperature.
- 5. The Min. value is 100%  $\,{\rm E}_{\rm AS}\,$  tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**

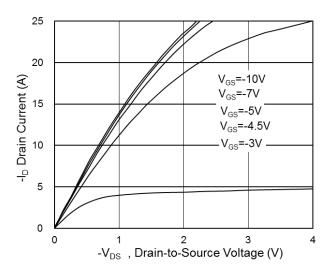


Fig.1 Typical Output Characteristics

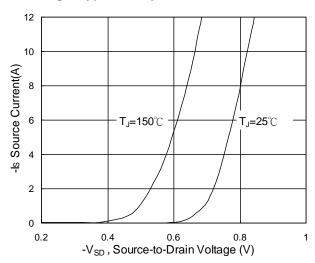


Fig.3 Typical S-D Diode Forward Voltage

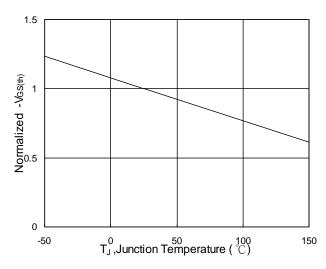


Fig.5 Normalized V<sub>GS(th)</sub> vs T<sub>J</sub>

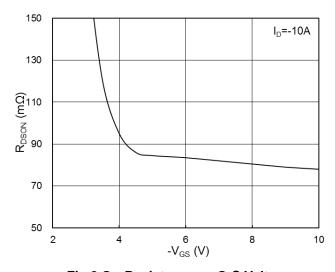


Fig.2 On-Resistance vs G-S Voltage

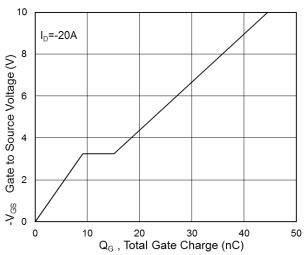


Fig.4 Gate-Charge Characteristics

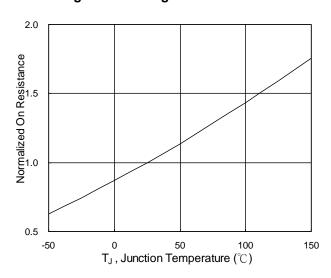
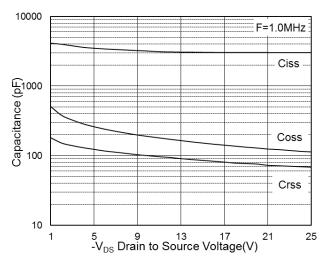


Fig.6 Normalized R<sub>DSON</sub> vs T<sub>J</sub>



# **Typical Characteristics (Cont.)**



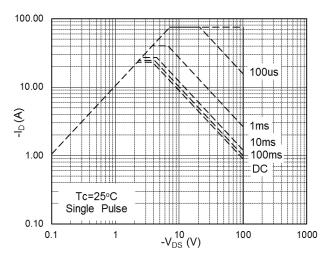


Fig.7 Capacitance



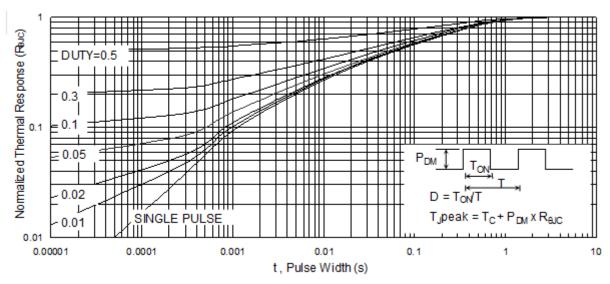


Fig.9 Normalized Maximum Transient Thermal Impedance

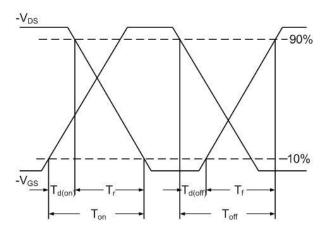
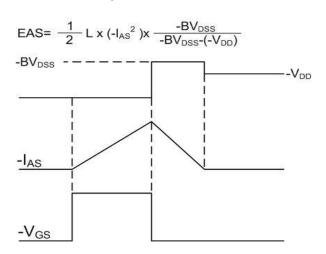


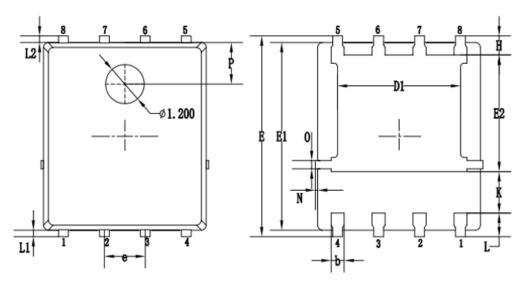
Fig.10 Switching Time Waveform

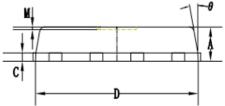


**Fig.11 Unclamped Inductive Waveform** 



# **Packaging information**





OVADOLO		MILLIMETERS			
SYMBOLS	MIN.	NOM.	MAX.		
Α	0.90	1.05	1.20		
b	0.35	0.40	0.50		
С	0.20	0.25	0.35		
D	4.90	5.05	5.20		
D1	3.72	3.82	3.92		
E	6.00	6.15	6.30		
E1	5.60	5.75	5.90		
E2	3.47	3.57	3.67		
е		1.27 BSC.			
Н	0.48	0.58	0.68		
K	1.17	1.27	1.37		
L	0.64	0.74 0.84			
L1/L2		0.20 REF.			
θ	8°	10°	12°		
М		0.08 REF.			
N	0	-	0.15		
0		0.25 REF.			
Р		1.28 REF.			



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